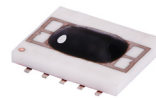


X2 Frequency Multiplier

50Ω Output 2200 to 3800 MHz

KC2-19+



Generic photo used for illustration purposes only

CASE STYLE: DZ885

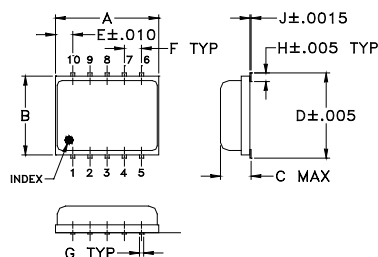
Maximum Ratings

Operating Temperature	-55°C to 100°C
Storage Temperature	-55°C to 100°C
RF Input, 25°C	200mW
Permanent damage may occur if any of these limits are exceeded.	

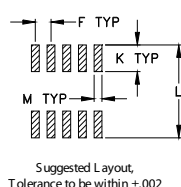
Pin Connections

INPUT	10
OUTPUT	5
50Ω TERMINATE EXT.	3
GROUND	1,2,4,6,7,8,9

Outline Drawing



PCB Land Pattern

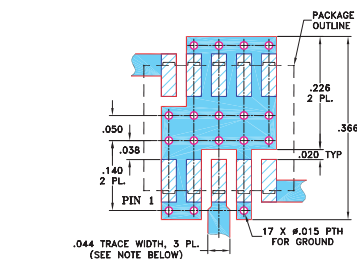


Suggested Layout,
Tolerance to be within ±.002

Outline Dimensions (inch)

A	B	C	D	E	F	G
.30	.250	.085	.266	.050	.050	.012
7.62	6.35	2.16	6.76	1.27	1.27	0.30
H	J	K	L	M		wt
.029	.004	.085	.296	.030		grams
0.74	0.10	2.16	7.52	0.76		0.25

Demo Board MCL P/N: TB-144 Suggested PCB Layout (PL-045)



- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 OZ, EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
3. DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
4. DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Features

- low conversion loss, 10.5 dB typ.
- LTCC design
- low profile, 0.085"
- low cost

Applications

- synthesizers
- local oscillators

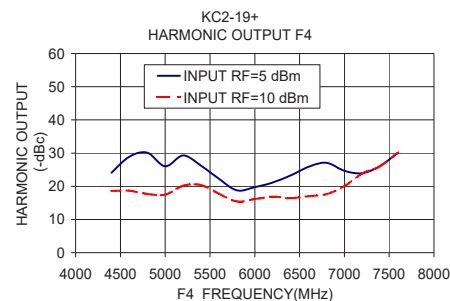
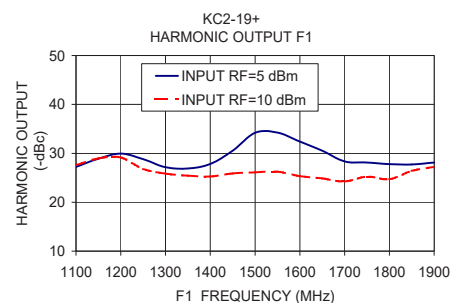
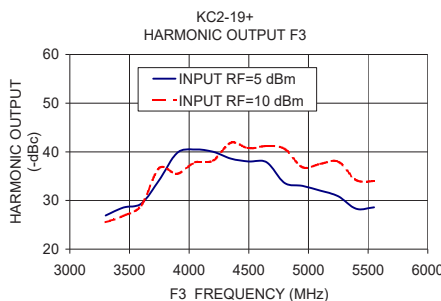
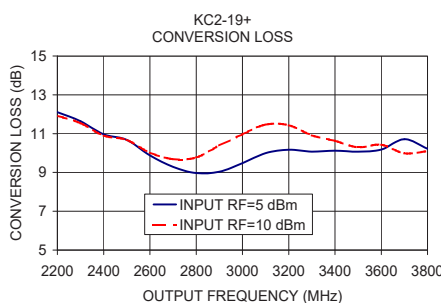
Electrical Specifications

MULTIPLICATION FACTOR	FREQUENCY (MHz)		INPUT POWER (dBm)		CONVERSION LOSS (dB)	*HARMONIC OUTPUT (dBc)					
	F1 Input	F2 Output	Min.	Max.		F1 Typ.	F1 Min.	F3 Typ.	F3 Min.	F4 Typ.	F4 Min.
2	1100-1900	2200-3800	5	10	10.5 14.6	24	18	30	18	17	12

* Harmonics of input frequency below the power level of F2

Typical Performance Data

Input Frequency (MHz)	INPUT RF= 5 dBm				INPUT RF= 10 dBm			
	Conversion Loss (dB)	Harmonic Output Below F2 (-dBc)			Conversion Loss (dB)	Harmonic Output Below F2 (-dBc)		
		F1	F3	F4		F1	F3	F4
1100.00	12.11	27.22	26.90	24.09	11.92	27.59	25.53	18.60
1200.00	10.96	29.96	29.37	30.10	10.90	29.15	29.02	17.70
1300.00	9.88	27.15	39.80	29.28	10.02	25.85	35.46	20.19
1400.00	8.97	27.83	40.01	22.24	9.77	25.27	38.18	17.75
1500.00	9.48	34.22	38.00	19.75	10.96	26.11	40.72	16.17
1550.00	10.00	34.23	37.86	21.15	11.46	26.25	41.21	16.88
1600.00	10.17	32.42	33.61	23.26	11.43	25.32	40.61	16.41
1650.00	10.07	30.54	33.01	25.89	10.91	24.88	36.81	17.03
1700.00	10.12	28.35	32.01	27.07	10.63	24.25	37.51	17.60
1750.00	10.07	28.10	30.86	24.69	10.30	25.22	37.99	20.05
1800.00	10.18	27.80	28.28	23.96	10.43	24.71	34.18	23.83
1850.00	10.71	27.71	28.58	26.17	9.99	26.42	33.97	26.09
1900.00	10.22	28.10	30.19	30.17	10.10	27.22	33.59	30.26



Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



Frequency Multiplier (Doubler)

KC2-19+

Typical Performance Data

FREQUENCY (MHz)				RF IN=+5dBm			
				CONVERSION LOSS (dB)	HARMONIC OUTPUT*		
				X 2 OUTPUT	X 1 OUTPUT	X 3 OUTPUT	X 4 OUTPUT
X 1 OUTPUT	X 2 OUTPUT	X 3 OUTPUT	X 4 OUTPUT				
1100	2200	3300	4400	12.11	27.22	26.90	24.09
1150	2300	3450	4600	11.64	28.91	28.56	28.91
1200	2400	3600	4800	10.96	29.96	29.37	30.10
1250	2500	3750	5000	10.68	28.82	34.21	26.01
1300	2600	3900	5200	9.88	27.15	39.80	29.28
1350	2700	4050	5400	9.29	26.91	40.49	26.19
1400	2800	4200	5600	8.97	27.83	40.01	22.24
1450	2900	4350	5800	9.04	30.55	38.61	18.78
1500	3000	4500	6000	9.48	34.22	38.00	19.75
1550	3100	4650	6200	10.00	34.23	37.86	21.15
1600	3200	4800	6400	10.17	32.42	33.61	23.26
1650	3300	4950	6600	10.07	30.54	33.01	25.89
1700	3400	5100	6800	10.12	28.35	32.01	27.07
1750	3500	5250	7000	10.07	28.10	30.86	24.69
1800	3600	5400	7200	10.18	27.80	28.28	23.96
1850	3700	5550	7400	10.71	27.71	28.58	26.17
1900	3800	5700	7600	10.22	28.10	30.19	30.17

*Harmonic Output below power level of X 2 Output .

FREQUENCY (MHz)				RF IN=+10dBm			
				CONVERSION LOSS (dB)	HARMONIC OUTPUT*		
				X 2 OUTPUT	X 1 OUTPUT	X 3 OUTPUT	X 4 OUTPUT
X 1 OUTPUT	X 2 OUTPUT	X 3 OUTPUT	X 4 OUTPUT				
1100	2200	3300	4400	11.92	27.59	25.53	18.60
1150	2300	3450	4600	11.54	28.98	26.84	18.69
1200	2400	3600	4800	10.90	29.15	29.02	17.70
1250	2500	3750	5000	10.68	26.81	36.66	17.47
1300	2600	3900	5200	10.02	25.85	35.46	20.19
1350	2700	4050	5400	9.69	25.43	37.84	20.36
1400	2800	4200	5600	9.77	25.27	38.18	17.75
1450	2900	4350	5800	10.39	25.90	41.85	15.47
1500	3000	4500	6000	10.96	26.11	40.72	16.17
1550	3100	4650	6200	11.46	26.25	41.21	16.88
1600	3200	4800	6400	11.43	25.32	40.61	16.41
1650	3300	4950	6600	10.91	24.88	36.81	17.03
1700	3400	5100	6800	10.63	24.25	37.51	17.60
1750	3500	5250	7000	10.30	25.22	37.99	20.05
1800	3600	5400	7200	10.43	24.71	34.18	23.83
1850	3700	5550	7400	9.99	26.42	33.97	26.09
1900	3800	5700	7600	10.10	27.22	33.59	30.26

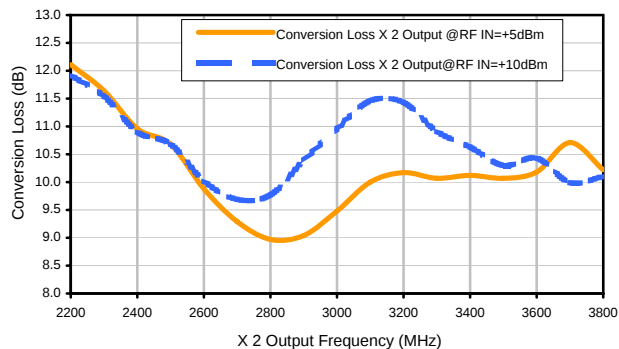
*Harmonic Output below power level of X 2 Output .

Frequency Multiplier (Doubler)

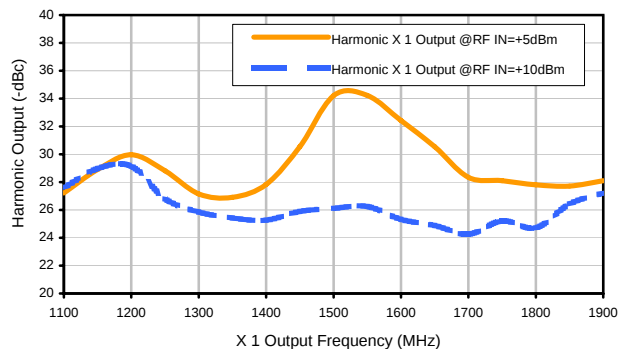
KC2-19+

Typical Performance Curves

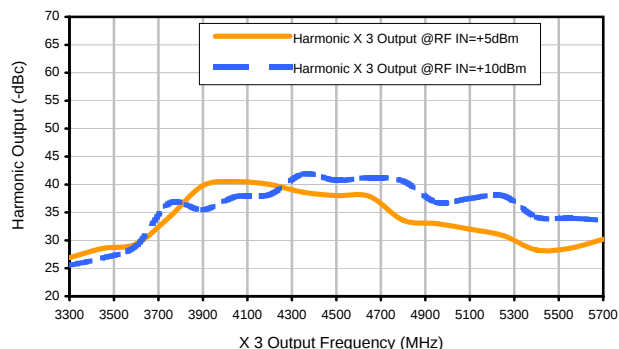
Conversion Loss X 2 Output



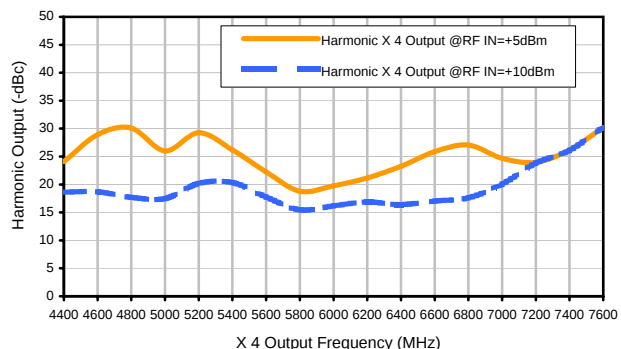
Harmonic X 1 Output



Harmonic X 3 Output

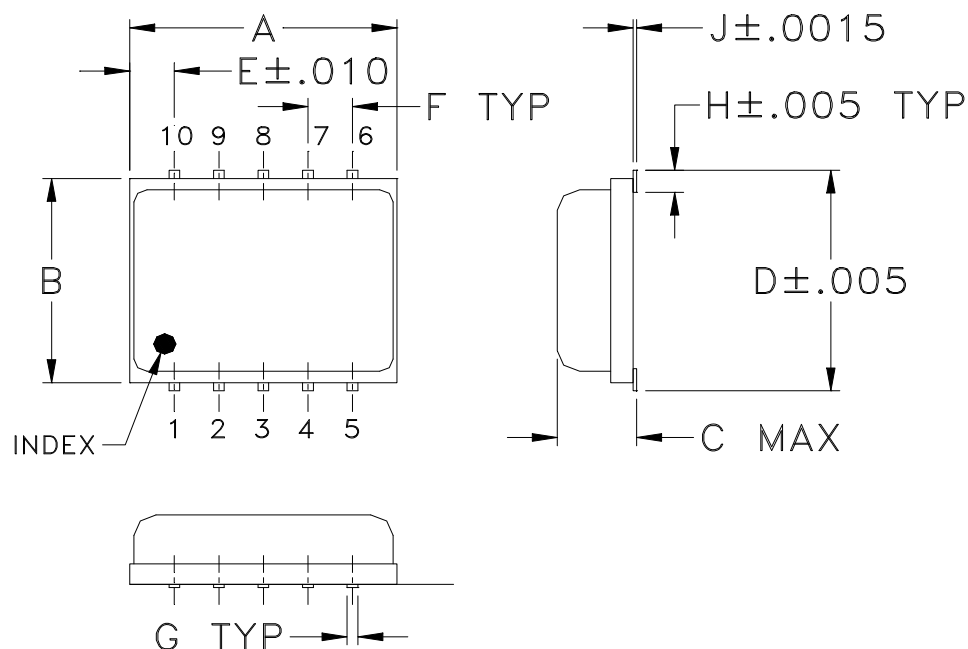


Harmonic X 4 Output

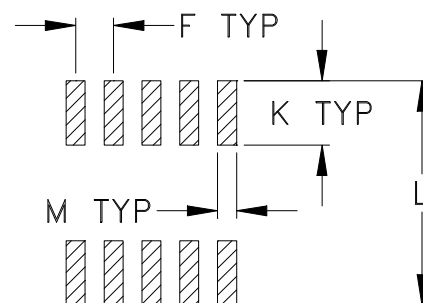


Outline Dimensions

DZ885
DZ1034



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm.002$

CASE#	A	B	C	D	E	F	G	H	J	K	L	M	WT. GRAMS
DZ885	.30 (7.62)	.250 (6.35)	.085 (2.16)	.266 (6.76)	.050 (1.27)	.050 (1.27)	.012 (0.30)	.029 (0.74)	.004 (0.10)	.085 (2.16)	.296 (7.52)	.030 (0.76)	0.25
DZ1034			.105 (2.67)										0.3

Dimensions are in inches (mm). Tolerances: 2Pl. $\pm .01$; 3Pl. $\pm .005$

Notes:

- Case material: Plastic encapsulation on Ceramic base.
- Termination finish:
 - For RoHS Case Styles: Tin plate. All models, (+) suffix.
 - For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



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Tape & Reel Packaging TR-F34



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note	
16	12	7	Small quantity standard (see note)	20
				50
				100
				200
		13	Standard	500
				1000

Note: Availability of small reel quantity varies by model.
Refer to pricing and availability on individual model dashboard.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

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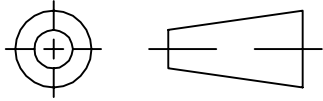
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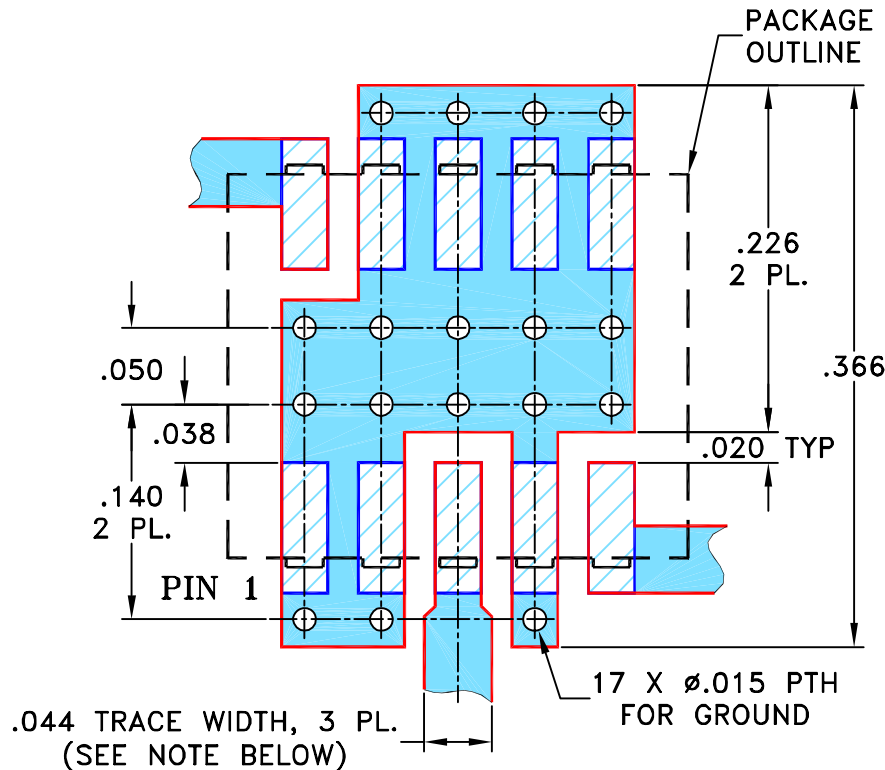
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
A	M81781	UPDATED PCB LAYOUT	06/07/02	GF	DJ
B	M82377	UPDATED DRAWING	07/31/02	AV	WL
C	M102713	ADDED NOTE 2 & "...WITH SMOBC"	01/17/06	MMG	IL
D	M135488	ADDED DZ1650, CHANGED PIN CONN.	02/02/12	GF	DJ

SUGGESTED MOUNTING CONFIGURATION FOR DZ883, DZ885 & DZ1650 CASE STYLES, "10MX01" PIN CONNECTION



- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020" $\pm$.0015"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC
(SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

DRAWN

AV

05/08/02

TOLERANCES ON:

CHECKED

DB

05/16/02

2 PL DECIMALS $\pm$

APPROVED

WL

05/16/02

3 PL DECIMALS $\pm$.005ANGLES $\pm$ FRACTIONS $\pm$

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ASHEETA1.DWG REV:A DATE:01/12/95



Mini-Circuits®

13 Neptune Avenue
Brooklyn NY 11235

PL, 10MX01, DZ883/885/1650, TB-144

SIZE

A

CODE IDENT

15542

DRAWING NO:

98-PL-045

REV:

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FILE:

98PL045

SCALE:

8:1

SHEET:

1 OF 1



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Autoclave	15 psig, 100% RH, 121°C, 96 hours	JESD22-A102-C, Condition C
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutectic Process: 225°C peak Pb-Free Process: 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2; Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215